

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KE SUN	07/05/2007
XIAO-ZHU CHEN	07/05/2007
RECEIVING PARTY DATA	
Name:	HONG FU JIN PRECISION INDUSTRY (ShenZhen) CO., LTD.
Street Address:	No. 2, 2nd Donghuan Road, Longhua Town, Bao' an District
City:	Shenzhen City, Guangdong Province
State/Country:	CHINA
Name:	HON HAI PRECISION INDUSTRY CO., LTD.
Street Address:	66, CHUNG SHAN ROAD
City:	Tu-Cheng, Taipei Hsien
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11778074
CORRESPONDENCE DATA	
Fax Number:	(714)738-4649
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	(714)626-1224
Email:	frank.niranjan@foxconn.com
Correspondent Name:	Frank Niranjan
Address Line 1:	458 E. Lambert Road
Address Line 4:	Fullerton, CALIFORNIA 92835
ATTORNEY DOCKET NUMBER:	US11510
NAME OF SUBMITTER:	Frank R. Niranjan

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Total Attachments: 2

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ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1. Ke Sun , residing at Shenzhen, Guangdong, China
2. Xiao-Zhu Chen , residing at Shenzhen, Guangdong, China
3. _____ , residing at _____
4. _____ , residing at _____
5. _____ , residing at _____
6. _____ , residing at _____
7. _____ , residing at _____
8. _____ , residing at _____

hereby sell(s), assign(s) and transfer(s) unto: HONG FU JIN PRECISION INDUSTRY (ShenZhen) CO., LTD. having a principal place of business at No.2, 2nd Donghuan Road, Longhua Town, Bao'an District, Shenzhen City, Guangdong Province 518109, P.R.C. and HON HAI PRECISION INDUSTRY CO., LTD. having a principal place of business at 66, Chung Shan Road, Tu-Cheng City, Taipei Hsien, Taiwan, R.O.C. hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as HEAT SINK HAVING HIGH HEAT DISSIPATION EFFICIENCY for which the undersigned

[] previously executed --- Ser. No. _____ and filing date of _____
[x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1. Ke Sun July 5, 2007 _____
Ke Sun inventor Date Witness

2. Xiao-Zhu Chen July 5, 2007 _____
Xiao-Zhu Chen inventor Date Witness

3. _____
inventor Date Witness

4. _____
inventor Date Witness

5. _____
inventor Date Witness

6. _____
inventor Date Witness

7. _____
inventor Date Witness

8. _____
inventor Date Witness